



# Eternal Semiconductor Inc.

## ES9926

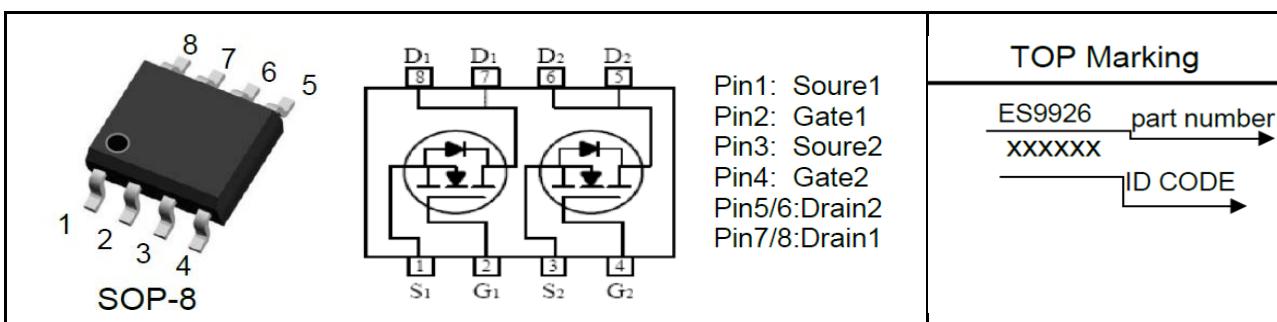
### Dual N-Channel High Density Trench MOSFET (20V, 6.0A)

#### PRODUCT SUMMARY

$V_{DSS}$	$I_D$	$R_{DS(on)}$ (mΩ)Max
20V	6.0A	22 @ $V_{GS} = 4.5V$ , $I_D = 6.0A$ 26 @ $V_{GS} = 2.5V$ , $I_D = 5.2A$

#### Features

- Advanced Trench Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Surface mount Package
- Lead (Pb)-free and halogen-free



#### Absolute Maximum Ratings ( $T_A=25^\circ C$ , unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D$	Drain Current (Continuous)	6	A
$I_{DM}$	Drain Current (Pulsed) <sup>a</sup>	20	A
$P_D$	Total Power Dissipation @ $T_A=25^\circ C$	2	W
$I_S$	Maximum Diode Forward Current	1.7	A
$T_j, T_{stg}$	Operating Junction and Storage Temperature Range	-55 to +150	°C
$R_{QJA}$	Thermal Resistance Junction to Ambient (PCB mounted) <sup>b</sup>	62	°C/W

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.

b: 1-in<sup>2</sup> 2oz Cu PCB board



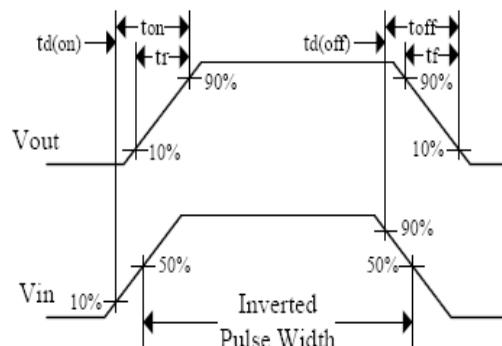
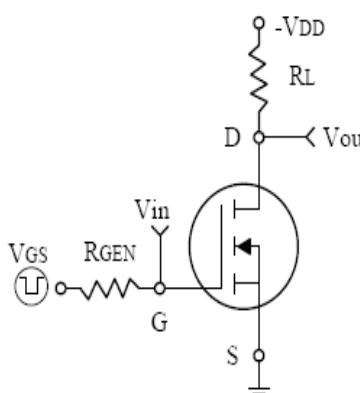
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**Electrical Characteristics** ( $T_A=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
<b>• Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	20	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>• On Characteristics</b>						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	0.6	0.65	1.2	V
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=2.8\text{A}$	-	22	28	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=2\text{A}$	-	26	40	
<b>• Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=6\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	559	-	PF
$C_{\text{oss}}$	Output Capacitance		-	148	-	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	127	-	
<b>• Switching Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{\text{DS}}=6\text{V}, I_{\text{D}}=5.4\text{A}, V_{\text{GS}}=4.5\text{V}$	-	5	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	0.9	-	
$Q_{\text{gd}}$	Gate-Drain Charge		-	1.4	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-6\text{V}, R_{\text{L}}=6\Omega, I_{\text{D}}=1\text{A}, V_{\text{GEN}}=4.5\text{V}, R_{\text{G}}=6\Omega$	-	10.2	-	nS
$t_r$	Turn-on Rise Time		-	7	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	33	-	
$t_f$	Turn-off Fall Time		-	6.8	-	
<b>• Drain-Source Diode Characteristics</b>						
$V_{\text{SD}}$	Drain-Source Diode Forward	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=1.7\text{A}$	-	-	1.2	V

Note: Pulse Test: Pulse Width  $\leq 300\text{us}$ , Duty Cycle  $\leq 2\%$



Switching Test Circuit and Switching Waveforms



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Typical Characteristics Curves (Ta=25°C, unless otherwise note)

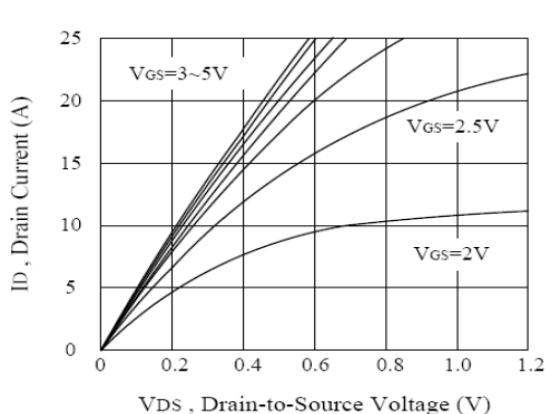


Figure 1. Output Characteristics

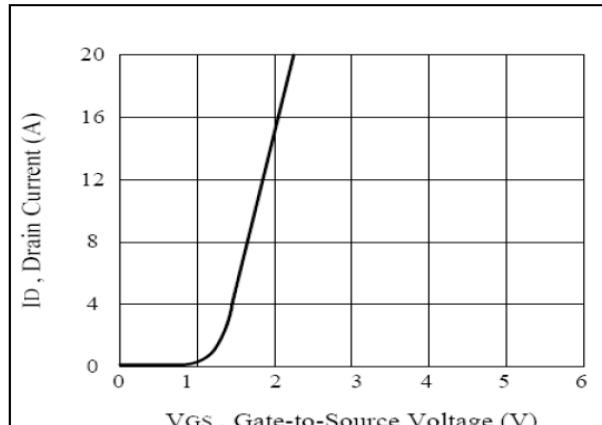


Figure 2. Transfer Characteristics

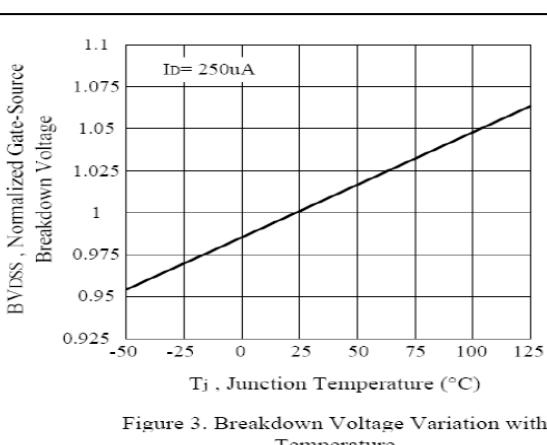


Figure 3. Breakdown Voltage Variation with Temperature

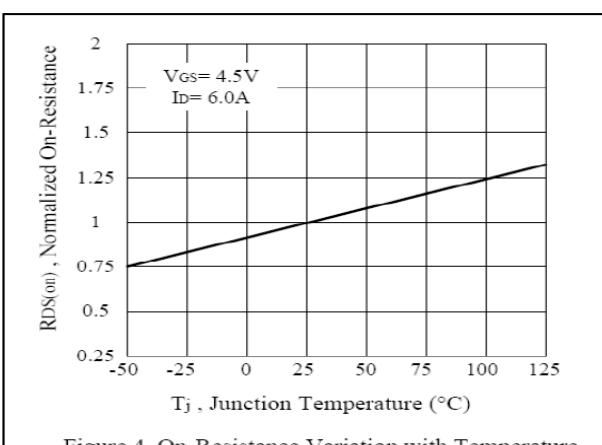


Figure 4. On-Resistance Variation with Temperature

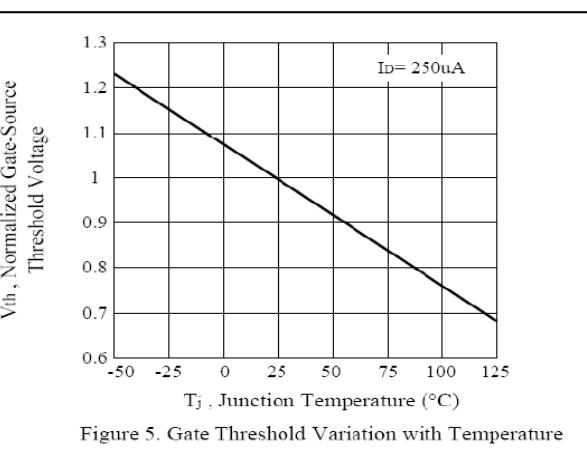


Figure 5. Gate Threshold Variation with Temperature

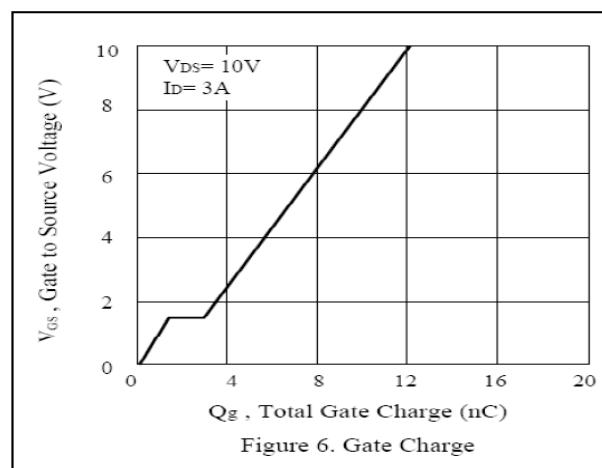


Figure 6. Gate Charge



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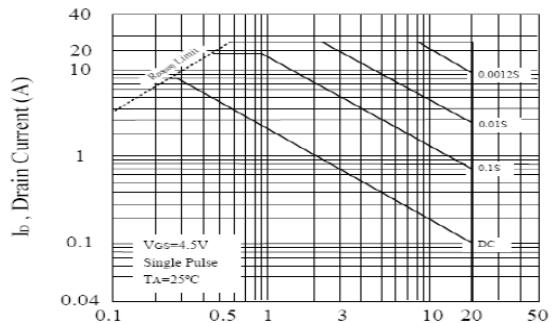


Figure 7. Maximum Safe Operating Area

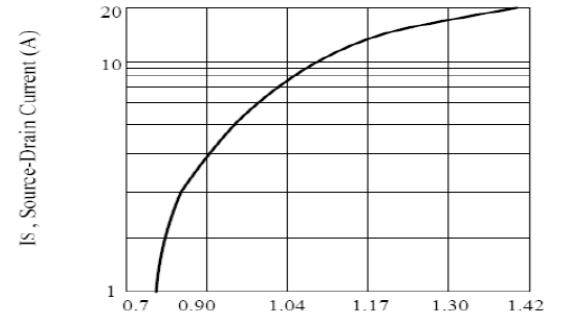


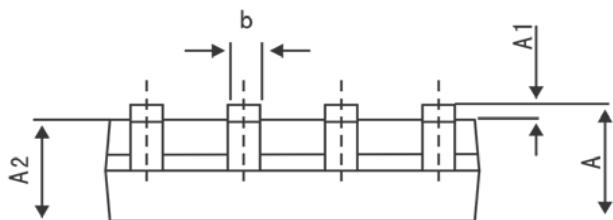
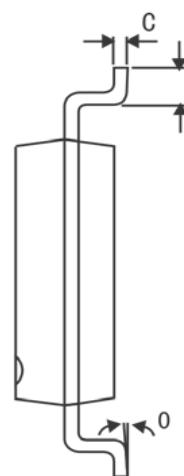
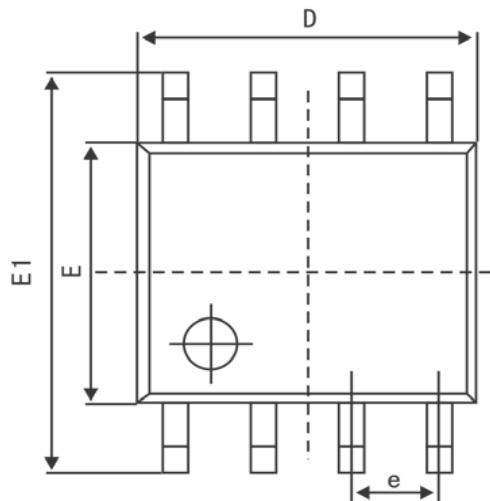
Figure 8. Body Diode Forward Voltage Variation with Source Current



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### ES9926 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters (MM)		Dimensions In Inches (MIL)	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°